DATE OF SUBMISSION

2017/ MM/ DD

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| EBA/SOI ASIA INTERNSHIP PROGRAM**APPLICATION FORM** |
| HOW TO SUBMITAfter filling out this form, please save and submit this application with following document via e-mail to: eba-internship-group@keio.jp with subject “Abbreviation of University-YOUR NAME: Application” such as “KEIO-Name: Application”.Required documents1. Resume
2. Transcript
3. Copy of English score (TOEIC, CU-TEP, TOEFL, IELTS, JLPT) <If any>
4. Recommendation letter <from professor/employers>

ATTENTION1. Names should be written in full, and not abbreviated.
2. Please note that we will not reveal personal information to anyone outside or on the Internet without your consent.

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| **About the applicant** |

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| Name:(As appears in Passport)  | First Name  | (Middle Name) Last Name  | Date of birth: (YYYY/MM/DD) |
| Nationality: | Gender: | Age: |
| Home address: |  | Zip code: |
| Affiliation (University, Faculty): | Education level (Bachelor/Master/Ph.D): | Student ID Number (Optional): |
| Expected year of graduation(YYYY/MM): | Passport No.:(Expired date: YYYY/MM/DD) | Skype account: |
| Department/Major: | Religion (Optional): |
| Home Phone/Mobile Phone: | E-mail: |
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| **Person to be notified in the applicant’s country, in case of emergency（Need 2 persons）** |

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| Name (in full):  |
| Home address:  | Zip code: |
| Home Phone/Mobile Phone: |
| Relationship with the applicant: |

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| Home address:  | Zip code: |
| Home Phone/Mobile Phone: |
| Relationship with the applicant: |

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| **INTERNSHIP DETAILS** |
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| **Virtual internship** | There will be 2 guidance session (10-15 minutes group presentation, 5 minutes Q&A).(Please tick “O” if you are convenient with the below schedule.) |
| Presentation schedule |  | 2017/04/07 |  | 2017/04/10 |  | 2017/04/11 |  | 2017/04/12 |
|  | 2017/04/19 |  | 2017/04/20 |  | 2017/04/21 |  | Other: 2017/04/\_\_  |
| Team member (If any) | No. | Full name | Department | Year of study |
| 1. |  |  |  |
| 2. |  |  |  |
| **Onsite internship** | Is 2017/07/15-08/06 convenient for you? (Please tick o if you are convenient with the below schedule.) |
| **Schedule** | 2017/07/15 | Departure from your country |
| 2016/07/16~17 | Workshop at Keio University |
| 2017/07/18~08/04 | Internship at Daikin (14 working days; Mon-Fri excluding national holiday) |
| 2017/08/05 | Back to home country |
|  | Above schedule is ok |  | Preferred schedule (YYYY/MM/DD): . |
| Is this internship for your credits? |  | Yes |  | No | Number of required weeks <if any>: .Other requirements from university?Please specify: |
| **1. What are your internship goal?** (Interest in full-time job with participating company, work experience, develop skills, or others) |
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| **2. Write the brief reasons why you are interested in the theme of *“Integration of Internet of Things (IOT) and air conditioners for friendly global environment, and convenience of life”*?** |
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| **3. Write your knowledge or past research/academic/ business experience which related to the project you choose. \*\*\*\*Specify your roles, responsibilities, results, and achievement in that experience\*\*\*\***(e.g. business plan contest, programming contest, oversea experience, internship experience, others) |
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| **4. Within this theme, what could you contribute to this internship and company?**(Things you would like to do in internship) |
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| **5. Your career path**5.1. What is your short-term plan after graduation? (e.g. continue higher education, work, startup business, others)5.2. Where do you see yourself in the next 5 years? How can you achieve that? |
| If you are interest to work in Japan, expected date to join company (YYYY/MM/DD):\_\_\_\_\_\_\_\_\_\_\_How long would you like to work there?\_\_\_\_\_ Years |
| **Special Instructions (Food restrictions, Health Condition, etc. ):** |
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| **Applicant’s English proficiency level:** | Attach your face photo (Photos must be in 6 months.The upper part of person's body, no hat): |
| Reading:🞎 Excellent 　🞎 Very good 　🞎 Fair 　🞎 Poor 　🞎 Very poor |   |
| Speaking:🞎 Excellent 　🞎 Very good 　🞎 Fair 　🞎 Poor 　🞎 Very poor |
| Writing:🞎 Excellent 　🞎 Very good 　🞎 Fair 　🞎 Poor 　🞎 Very poor |
| Listening:🞎 Excellent 　🞎 Very good 　🞎 Fair 　🞎 Poor 　🞎 Very poor |
| If the applicant has any supporting score in English, please write below: |
| TOEFL:\_\_\_\_\_ scores | Test date: (YYYY/MM/DD) |
| TOEIC: \_\_\_\_\_ scores | Test date: (YYYY/MM/DD) |
| Other language (e.g. Japanese JLPT): |  |
| If the applicant has any additional skills, please write below:(e.g.: business planning, research skills, computer network, TCP/IP, programming skills, engineering skills, or others) |
| Web development | 🞎 Excellent 　🞎 Very good 　🞎 Fair 　🞎 Poor 　🞎 Very poorProgramming language: |
| Mobile development | 🞎 Excellent 　🞎 Very good 　🞎 Fair 　🞎 Poor 　🞎 Very poorPrograming language: |
| Knowledge related to IOT | 🞎 Excellent 　🞎 Very good 　🞎 Fair 　🞎 Poor 　🞎 Very poor |
|  | Test date (If any): (YYYY/MM/DD) |
|  | Certificate issued date (If any): (YYYY/MM/DD) |

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| **NOTES** |

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| **VISA INFORMATION**You may need visa to enter the country where your internship or fieldwork will be held. Please check with the host organization's national diplomatic or consular mission in your country to find more information about visa application procedures. It is recommended that this process be started as soon as possible. The host organization will provide invitation letters and/or other required documents for your visa application. Please note that these documents do not guarantee that you will receive a visa. Please note that in most cases, **passports must be valid for at least six months in order to obtain a visa**. All costs related to visa issue must be paid by the applicant.  |

Receipt (Please do not fill in this column)：